Form PTO-1595 (Rev. 03/05) OMB No. 0651-0027 (exp. 6/30/2005)	1 - 2005  U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office		
To the Director of the U.S. Pater 1031	09960		
Name of conveying party(ies)	2. Name and address of receiving party(ies)		
William Wei-Yuan Tien Fu-Hsin Chen	Name: Taiwan Semiconductor Manufacturing Company,		
Jui-Wen Lin You-Kuo Wu	Ltd.		
	Internal Address:		
Additional name(s) of conveying party(ies) attached? Yes X	No September 1		
3. Nature of conveyance/Execution Date(s):  Execution Date(s) October 4, 2005	<del></del>		
X Assignment Merger	Street Address: No. 8, Li-Hsin Rd. 6		
Security Agreement Change of Name	Science-Based Industrial Park		
Joint Research Agreement	City Hain Chu		
Government Interest Assignment	City: Hsin-Chu		
Executive Order 9424, Confirmatory License	State: Taiwan		
	Country: ROC Zip:300-77		
Other	Additional name(s) & address(es) attached? Yes X No		
5. Name and address to whom correspondence	6. Total number of applications and patents		
concerning document should be mailed:	involved:1		
Name: Steven H. Slater	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00		
Slater & Matsil, L.L.P.	Authorized to be charged by credit card		
Internal Address:	X Authorized to be charged to deposit account		
Street Address: 17950 Preston Rd.	Enclosed		
Suite 1000	None required (government interest not affecting title)		
City: Dallas	8. Payment Information		
State:         Texas         Zip:         75252-5793			
Phone Number: <u>972-732-1001</u>	a. Credit Card Last 4 Numbers Expiration Date		
Fax Number: <u>972-732-9218</u>	b. Deposit Account Number 50-1065		
Email Address: slater@slater-matsil.com			
	Authorized User Name Gregory T. Neugebauer		
9. Signature:	October 19, 2005		
Signature	Date		
Gregory T. Neugebauer, Reg. No. 53,378	Total number of pages including cover sheet, attachments, and documents: 2		
Name of Person Signing			

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:

Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, V.A. 22313-1450

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ATTORNEY DOCKET NO. TSM05-0182

## ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. (TSMC), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C., is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TSMC, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TSMC, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to TSMC, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TSMC, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TSMC, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	High Voltage Transistor with Improved Driving Current			
SIGNATURE OF INVENTOR AND NAME	William Wei-Yuan Tien	Fu-HSIA Chen Fu-Hsin Chen	Jui-Wan Lui Jui-Wen Lin	You-Kuo Wu
DATE	10/4/2005	10/4/2005	(0/4/2005	10/4/2005
RESIDENCE (City, County, State)	Hsinchu, 300-77 Taiwan, R.O.C.	Jhudong Township, 310 Taiwan, R.O.C.	Taichung City, 408 Taiwan, R.O.C.	Sijhih City, 221 Taiwan, R.O.C.

Assignment

TSM05-0182

RECORDED: 10/19/2005

Page 1 of 1